

Multicore Lead-Free Solder Wire - 502

Product Images



Description

SAFETY DIRECT

- No-clean, clear residue, minimal activation for increased wetting speed
- Composition: 95.5% SN, 3.8% Ag, 0.7% CU
- Halide Content: 0.2%
- IPC Class: ROM1
- Flux Content by Weight: 3%